



TE0823 Test Board

Revision v.13

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Online version of this document:

<https://wiki.trenz-electronic.de/display/PD/TE0823+Test+Board>

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4 Overview

ZynqMP PS Design with Linux Example and simple frequency counter to measure SI5338 Reference CLK with Vivado HW-Manager.

Wiki Resources page: <http://trenz.org/te0823-info>

4.1 Key Features

- Vitis/Vivado 2021.2.1
- PetaLinux
- SD
- ETH
- USB
- I2C
- RTC
- FMeter
- MAC from EEPROM
- User LED
- Modified FSBL for SI5338 programming
- Special FSBL for QSPI programming

4.2 Revision History

| Date | Vivado | Project Built | Authors | Description |
|------------|----------|---|------------------|---|
| 2022-11-08 | 2021.2.1 | TE0823-test_board_noprebuild-t-vivado_2021.2-build_20_20221108082219.zip TE0823-test_board-vivado_2021.2-build_20_20221108082219.zip | Manuela Strücker | <ul style="list-style-type: none"> • bugfix uncomment block design modifications in mod_bd.tcl • added jtag2axi for test purposes |
| 2022-10-25 | 2021.2.1 | TE0823-test_board_noprebuild-t-vivado_2021.2-build_19_20221025110452.zip TE0823-test_board-vivado_2021.2-build_19_20221025110452.zip | Manuela Strücker | <ul style="list-style-type: none"> • Release Vivado 2021.2.1 • script update |

| Date | Vivado | Project Built | Authors | Description |
|------------|--------|---|------------------------------------|---|
| 2021-10-27 | 2020.2 | TE0823-test_board_noprebuild-t-vivado_2020.2-build_8_20211027094814.zip TE0823-test_board-vivado_2020.2-build_8_20211027094802.zip | Mohsen Chamanbaz/ John Hartfiel | <ul style="list-style-type: none"> replace 19.2 fsbl template with 20.2 new variants |
| 2021-08-24 | 2020.2 | TE0823-test_board_noprebuild-t-vivado_2020.2-build_7_20210824103952.zip TE0823-test_board-vivado_2020.2-build_7_20210824103936.zip | Mohsen Chamanbaz | <ul style="list-style-type: none"> startup application added webfwu application added |
| 2021-08-17 | 2020.2 | TE0823-test_board_noprebuild-t-vivado_2020.2-build_7_20210817113507.zip TE0823-test_board-vivado_2020.2-build_7_20210817113435.zip | Mohsen Chamanbaz | <ul style="list-style-type: none"> 2020.2 release |
| 2020-03-16 | 2019.2 | TE0823-test_board-vivado_2019.2-build_8_20200316163150.zip TE0823-test_board_noprebuild-t-vivado_2019.2-build_8_20200316163202.zip | John Hartfiel | <ul style="list-style-type: none"> initial release |

Table 1: Design Revision History

4.3 Release Notes and Know Issues

| Issues | Description | Workaround | To be fixed version |
|-----------------|---|---|---------------------|
| Xilinx Software | Incompatibility of board files for ZynqMP with eMMC activated for Vivado versions below/equal to 2021.2 and 2021.2.1 patch, see Xilinx Forum Request ¹ | use corresponding board files for the Vivado versions | -- |

Table 2: Known Issues

4.4 Requirements

4.4.1 Software

| Software | Version | Note |
|---------------------|----------|--|
| Vitis | 2021.2.1 | needed Vivado is included into Vitis installation |
| PetaLinux | 2021.2 | needed |
| SI ClockBuilder Pro | --- | optional |

Table 3: Software

4.4.2 Hardware

Basic description of TE Board Part Files is available on [TE Board Part Files](#).²

Complete List is available on "<project folder>\board_files*_board_files.csv"

Design supports following modules:

¹ https://support.xilinx.com/s/feed/0D54U00005Wbon6SAB?language=en_US

² <https://wiki.trenz-electronic.de/display/PD/TE+Board+Part+Files>

| Module Model | Board Part Short Name | PCB Revision Support | DDR | QSPI Flash | EMMC | Others | Notes |
|-------------------|-----------------------|----------------------|-----|------------|------|--------|--|
| TE0823-01-3PIU1FL | 3cg_1li_1gb | REV01 | 1GB | 128MB | 8GB | NA | Low Profile Connector |
| TE0823-01-3PIU1FA | 3cg_1li_1gb | REV01 | 1GB | 128MB | 8GB | NA | NA |
| TE0823-01-S001 | 3cg_1li_2gb | REV01 | 2GB | 128MB | 8GB | NA | Custom, AN:3PI?1FA |
| TE0823-01-3PIU1ML | 3cg_1li_1gb | REV01 | 1GB | 128MB | 8GB | NA | Low Profile Connector, other emmC Manuf. |
| TE0823-01-3PIU1MA | 3cg_1li_1gb | REV01 | 1GB | 128MB | 8GB | NA | other emmC Manuf. |
| TE0823-01-S002 | 3cg_1li_2gb | REV01 | 2GB | 128MB | 8GB | NA | Custom, other emmC Manuf., AN:3PI?1FA |

Table 4: Hardware Modules

*used as reference

Design supports following carriers:

| Carrier Model | Notes |
|---------------|---|
| TE0701 | <ul style="list-style-type: none"> Important: See restrictions on usage with 7 Serie Carriers: 4 x 5 SoM Carriers³ |
| TE0703* | <ul style="list-style-type: none"> Important: See restrictions on usage with 7 Serie Carriers: 4 x 5 cm carriers⁴ Used as reference carrier. |

³ <https://wiki.trenz-electronic.de/display/PD/4+x+5+SoM+Carriers>

⁴ <https://wiki.trenz-electronic.de/display/PD/4+x+5+SoM+Carriers>

| Carrier Model | Notes |
|---------------|--|
| TE0705 | <ul style="list-style-type: none"> Important: See restrictions on usage with 7 Serie Carriers: 4 x 5 SoM Carriers⁵ |
| TE0706 | <ul style="list-style-type: none"> Important: See restrictions on usage with 7 Serie Carriers: 4 x 5 SoM Carriers⁶ |
| TEBA0841 | <ul style="list-style-type: none"> Important: See restrictions on usage with 7 Serie Carriers: 4 x 5 SoM Carriers⁷ No SD Slot available, pins goes to Pin Header For TEBA0841 REV01, please contact TE support |
| TEF1001 | <ul style="list-style-type: none"> Important: See restrictions on usage with 7 Serie Carriers: 4 x 5 SoM Carriers⁸ |

Table 5: Hardware Carrier

* used as reference

Additional HW Requirements:

| Additional Hardware | Notes |
|-------------------------|--|
| USB Cable for JTAG/UART | Check Carrier Board and Programmer for correct typ |
| XMOD Programmer | Carrier Board dependent, only if carrier has no own FTDI |
| Cooler | It's recommended to use cooler on ZynqMP device |

Table 6: Additional Hardware

* used as reference

4.5 Content

For general structure and of the reference design, see [Project Delivery - AMD devices](#)⁹

4.5.1 Design Sources

⁵ <https://wiki.trenz-electronic.de/display/PD/4+x+5+SoM+Carriers>

⁶ <https://wiki.trenz-electronic.de/display/PD/4+x+5+SoM+Carriers>

⁷ <https://wiki.trenz-electronic.de/display/PD/4+x+5+SoM+Carriers>

⁸ <https://wiki.trenz-electronic.de/display/PD/4+x+5+SoM+Carriers>

⁹ <https://wiki.trenz-electronic.de/display/PD/Project+Delivery+-+AMD+devices>

| Type | Location | Notes |
|-----------|--|---|
| Vivado | <project folder>\block_design <project folder>\constraints <project folder>\ip_lib <project folder>\board_files | Vivado Project will be generated by TE Scripts |
| Vitis | <project folder>\sw_lib | Additional Software Template for Vitis and apps_list.csv with settings automatically for Vitis app generation |
| PetaLinux | <project folder>\os\petalinux | PetaLinux template with current configuration |

Table 7: Design sources

4.5.2 Additional Sources

| Type | Location | Notes |
|---------|----------------------------------|---|
| SI5338 | <project folder>\misc\PLL\Si5338 | SI5338 Project with current PLL Configuration |
| init.sh | <project folder>\misc\sd | Additional Initialization Script for Linux |

Table 8: Additional design sources

4.5.3 Prebuilt

| File | File-Extension | Description |
|----------|----------------|---|
| BIF-File | *.bif | File with description to generate Bin-File |
| BIN-File | *.bin | Flash Configuration File with Boot-Image (Zynq-FPGAs) |

| File | File-Extension | Description |
|------------------------------------|----------------|---|
| BIT-File | *.bit | FPGA (PL Part) Configuration File |
| Boot Script-File | *.scr | Distro Boot Script file |
| DebugProbes-File | *.ltx | Definition File for Vivado/Vivado Labtools Debugging Interface |
| Diverse Reports | --- | Report files in different formats |
| Device Tree | *.dts | Device tree (2 possible, one for u-boot and one for linux) |
| Hardware-Platform-Description-File | *.xsa | Exported Vivado hardware description file for Vitis and PetaLinux |
| LabTools Project-File | *.lpr | Vivado Labtools Project File |
| OS-Image | *.ub | Image with Linux Kernel (On Petalinux optional with Devicetree and RAM-Disk) |
| Software-Application-File | *.elf | Software Application for Zynq or MicroBlaze Processor Systems |

Table 9: Prebuilt files (only on ZIP with prebuilt content)

4.5.4 Download

Reference Design is only usable with the specified Vivado/Vitis/PetaLinux version. Do never use different Versions of Xilinx Software for the same Project.

Reference Design is available on:

- [TE0823 "Test Board" Reference Design](https://shop.trenz-electronic.de/Download/?path=Trenz_Electronic/Modules_and_Module_Carriers/4x5/TE0823/Reference_Design/2021.2/test_board)¹⁰

¹⁰ https://shop.trenz-electronic.de/Download/?path=Trenz_Electronic/Modules_and_Module_Carriers/4x5/TE0823/Reference_Design/2021.2/test_board

5 Design Flow

⚠ Reference Design is available with and without prebuilt files. It's recommended to use TE prebuilt files for first launch.

Trenz Electronic provides a tcl based built environment based on Xilinx Design Flow.

See also:

- [AMD Development Tools](#)¹¹
- [Vivado Projects - TE Reference Design](#)¹²
- [Project Delivery](#).¹³

The Trenz Electronic FPGA Reference Designs are TCL-script based project. Command files for execution will be generated with "_create_win_setup.cmd" on Windows OS and "_create_linux_setup.sh" on Linux OS.

TE Scripts are only needed to generate the vivado project, all other additional steps are optional and can also be executed by Xilinx Vivado/SDK GUI. For currently Scripts limitations on Win and Linux OS see: [Project Delivery Currently limitations of functionality](#)¹⁴

⚠ Caution! Win OS has a 260 character limit for path lengths which can affect the Vivado tools. To avoid this issue, use Virtual Drive or the shortest possible names and directory locations for the reference design (for example "x:\<project folder>")

1. Run _create_win_setup.cmd/_create_linux_setup.sh and follow instructions on shell:

```

_create_win_setup.cmd/_create_linux_setup.sh

-----Set design paths-----
-- Run Design with: _create_win_setup
-- Use Design Path: <absolute project path>
-----
-----TE Reference Design-----
-----
-- (0)  Module selection guide, project creation...prebuilt export...
-- (1)  Create minimum setup of CMD-Files and exit Batch
-- (2)  Create maximum setup of CMD-Files and exit Batch
-- (3)  (internal only) Dev
-- (4)  (internal only) Prod
-- (c)  Go to CMD-File Generation (Manual setup)
-- (d)  Go to Documentation (Web Documentation)
-- (g)  Install Board Files from Xilinx Board Store (beta)
-- (a)  Start design with unsupported Vivado Version (beta)
-- (x)  Exit Batch (nothing is done!)
-----
Select (ex.: '0' for module selection guide):

```

2. Press 0 and enter to start "Module Selection Guide"

¹¹ <https://wiki.trenz-electronic.de/display/PD/AMD+Development+Tools#AMDDDevelopmentTools-XilinxSoftware-BasicUserGuides>

¹² <https://wiki.trenz-electronic.de/display/PD/Vivado+Projects+-+TE+Reference+Design>

¹³ <https://wiki.trenz-electronic.de/display/PD/Project+Delivery+-+AMD+devices>

¹⁴ <https://wiki.trenz-electronic.de/display/PD/Project+Delivery+-+AMD+devices#ProjectDeliveryAMDdevices-Currentlylimitationsoffunctionality>

3. Create project and follow instructions of the product selection guide, settings file will be configured automatically during this process.
 - optional for manual changes: Select correct device and Xilinx install path on "design_basic_settings.cmd" and create Vivado project with "vivado_create_project_gui mode.cmd"

 Note: Select correct one, see also [Vivado Board Part Flow](#)¹⁵

4. Create hardware description file (.xsa file) for PetaLinux project and export to prebuilt folder

run on Vivado TCL (Script generates design and export files into "\prebuilt\hardware\")

```
\prebuilt\hardware\")">
TE::hw_build_design -export_prebuilt
```

 Using Vivado GUI is the same, except file export to prebuilt folder.

5. Create and configure your PetaLinux project with exported .xsa-file, see [PetaLinux KICKstart](#)¹⁶
 - use TE Template from "<project folder>\os\petalinux"
 - use exported .xsa file from "<project folder>\prebuilt\hardware\<short name>". **Note:** HW Export from Vivado GUI creates another path as default workspace.
 - The build images are located in the "<plnx-proj-root>/images/linux" directory
6. Configure the **boot.scr** file as needed, see [Distro Boot with Boot.scr](#)¹⁷
7. Copy PetaLinux build image files to prebuilt folder
 - copy **u-boot.elf**, **u-boot.dtb**, **system.dtb**, **image.ub**, **bl31.elf** and **boot.scr** from "<plnx-proj-root>/images/linux" to prebuilt folder

 "<project folder>\prebuilt\os\petalinux\<ddr size>" or "<project folder>\prebuilt\os\petalinux\<short name>"

8. Generate Programming Files with Vitis

run on Vivado TCL (Script generates applications and bootable files, which are defined in "test_board\sw_lib\apps_list.csv")

```
TE::sw_run_vitis -all
TE::sw_run_vitis (optional; Start Vitis from Vivado GUI or start with TE
Scripts on Vivado TCL)
```

 TCL scripts generate also platform project, this must be done manually in case GUI is used. See [Vitis](#)¹⁸

¹⁵ <https://wiki.trenz-electronic.de/display/PD/Vivado+Board+Part+Flow>

¹⁶ <https://wiki.trenz-electronic.de/display/PD/PetaLinux+KICKstart>

¹⁷ <https://wiki.trenz-electronic.de/display/PD/Distro+Boot+with+Boot.scr>

¹⁸ <https://wiki.trenz-electronic.de/display/PD/Vitis>

6 Launch

6.1 Programming

- ⚠** Check Module and Carrier TRMs for proper HW configuration before you try any design. Reference Design is also available with prebuilt files. It's recommended to use TE prebuilt files for first launch.

Xilinx documentation for programming and debugging: [Vivado/Vitis/SDSoC-Xilinx Software Programming and Debugging](#)¹⁹

Note: Depending on CPLD Firmware and Boot Mode settings, QSPI boot with Linux image on SD or complete SD Boot is possible.

6.1.1 Get prebuilt boot binaries

1. Run `_create_win_setup.cmd/_create_linux_setup.sh` and follow instructions on shell
2. Press 0 and enter to start "Module Selection Guide"
 - a. Select assembly version
 - b. Validate selection
 - c. Select Create and open delivery binary folder

i Note: Folder "`<project folder>_binaries_<Article Name>`" with subfolder "`boot_<app name>`" for different applications will be generated

6.1.2 QSPI-Boot mode

Option for **Boot.bin** on QSPI Flash and **image.ub** and **boot.scr** on **SD** or **USB**.

1. Connect **JTAG** and power on carrier with module
2. Open Vivado Project with "`vivado_open_existing_project_guiemode.cmd`" or if not created, create with "`vivado_create_project_guiemode.cmd`"

run on Vivado TCL (Script programs **BOOT.bin** on QSPI flash)

```
TE::pr_program_flash -swapp u-boot
TE::pr_program_flash -swapp hello_te0823 (optional)
```

3. Copy **image.ub** and **boot.scr** on **SD** or **USB**
 - use files from "`<project folder>_binaries_<Article Name>\boot_linux`" from generated binary folder, see: [Get prebuilt boot binaries](#) (see page 16)
 - or use prebuilt file location, see "`<project folder>\prebuilt\file_location.txt`"
4. Set Boot Mode to **QSPI-Boot** and insert **SD** or **USB**.
 - Depends on Carrier, see carrier TRM.

¹⁹ <https://wiki.trenz-electronic.de/display/PD/AMD+Development+Tools#AMDDDevelopmentTools-XilinxSoftwareProgrammingandDebugging>

6.1.3 SD-Boot mode

1. Copy **image.ub**, **boot.src** and **Boot.bin** on **SD**
 - use files from "<project folder>_binaries_<Article Name>\boot_linux" from generated binary folder, see: [Get prebuilt boot binaries](#)(see page 16)
 - or use prebuilt file location, see "<project folder>\prebuilt\file_location.txt"
2. Set Boot Mode to SD-Boot.
 - Depends on Carrier, see carrier TRM.
3. Insert SD-Card in SD-Slot.

6.1.4 JTAG

Not used on this Example.

6.2 Usage

1. Prepare HW like described on section [Programming](#)(see page 16)
2. Connect UART USB (most cases same as JTAG)
3. Select SD Card or QSPI as Boot Mode (Depends on used programming variant)

 Note: See TRM of the Carrier, which is used.

 Starting with Petalinux version 2020.1, the industry standard "Distro-Boot" boot flow for U-Boot was introduced, which significantly expands the possibilities of the boot process and has the primary goal of making booting much more standardised and predictable. The boot options described above describe the common boot processes for this hardware; other boot options are possible. For more information see [Distro Boot with Boot.scr](#)²⁰

4. Power On PCB
boot process
 1. ZynqMP Boot ROM loads PMU Firmware and FSBL from SD/QSPI Flash into OCM
 2. FSBL init PS, programs PL using the bitstream and loads U-boot from SD into DDR,
 3. U-boot loads Linux (**image.ub**) from SD/QSPI/... into DDR

6.2.1 Linux

1. Open Serial Console (e.g. putty)
 - Speed: 115200
 - Select COM Port

 Win OS, see device manager, Linux OS see `dmesg |grep tty` (UART is *USB1)

2. Linux Console:

²⁰ <https://wiki.trenz-electronic.de/display/PD/Distro+Boot+with+Boot.scr>

```
# password default disabled with 2021.2 petalinux release
petalinux login: root
Password: root
```

Note: Wait until Linux boot finished

3. You can use Linux shell now.

```
i2cdetect -y -r 0    (check I2C 0 Bus)
dmesg | grep rtc    (RTC check)
udhcpc              (ETH0 check)
lsusb               (USB check)
```

4. Option Features

- Webservice to get access to Zynq
 - insert IP on web browser to start web interface
- init.sh scripts
 - add init.sh script on SD, content will be load automatically on startup (template included in "<project folder>\misc\SD")

6.2.2 Vivado HW Manager

Open Vivado HW-Manager and add VIO signal to dashboard (*.ltx located on prebuilt folder).

Control:

- GTR Power: set X0=0 and X1=1 to disable GTR Power
- USER LED: On/OFF

Monitoring:

- SI5338_CLK0 Counter: 200MHz with example Design
 - Set radix from VIO signals to unsigned integer.
 Note: Frequency Counter is inaccurate and displayed unit is Hz
- ETH PHY LEDs

The screenshot shows the Vivado Hardware Manager interface. On the left, the 'Hardware' pane displays a tree view of the system components, including 'localhost (1)', 'xilinx_tcf/Digilent/251633002673A', and 'xczu3_0 (3)'. The 'xczu3_0 (3)' component is expanded, showing sub-components like 'SysMon (System Monitor)', 'hw_vio_1 (zusys_ifvio_0)', 'mt25qu512-qspi-x8-dual_par', and 'arm_dap_1 (1)'. The 'hw_vio_1' component is selected, and its status is 'OK - Outputs Reset'. On the right, the 'hw_vios' dashboard is displayed, showing a table of VIO signals. The table has columns for Name, Value, Action, Direction, and VIO. The signals listed are: 'zusys_ifm_SI5338_CLK0_D[31:0]' (Value: [U] 200000072, Input), 'zusys_iflabtools_fmeter_0_update' (Value: [B] 0, Input), 'zusys_ifPHY_LED[0:0]' (Value: [B] 1, Input), 'zusys_ifUSRLED[0:0]' (Value: [B] 0, Output), 'zusys_ifx0[0:0]' (Value: [B] 0, Output), and 'zusys_ifx1[0:0]' (Value: [B] 0, Output).

Figure 1: Vivado Hardware Manager

7 System Design - Vivado

7.1 Block Design

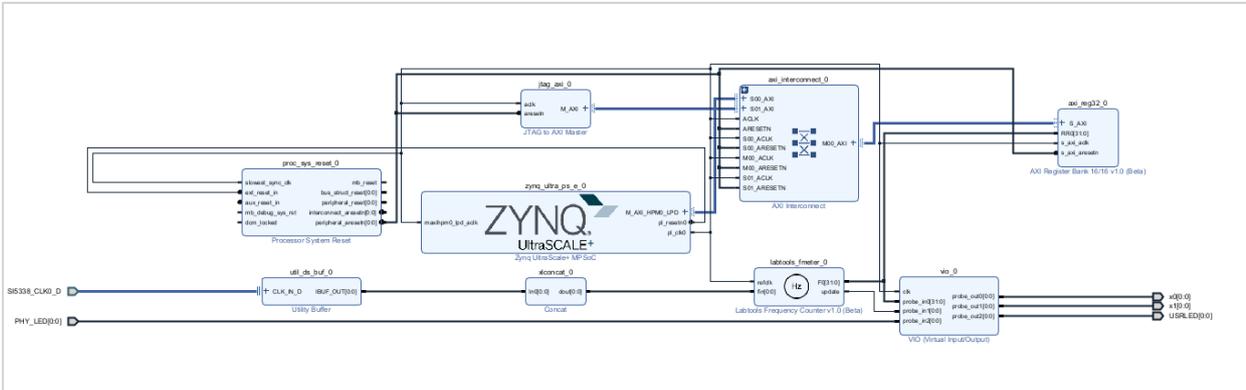


Figure 2: Block Design

7.1.1 PS Interfaces

Activated interfaces:

| Type | Note |
|----------|------|
| DDR | |
| QSPI | MIO |
| SD0 | MIO |
| SD1 | MIO |
| I2C0 | MIO |
| UART0 | MIO |
| GPIO0 | MIO |
| SWDT0..1 | |

| Type | Note |
|---------|----------------|
| TTC0..3 | |
| GEM3 | MIO |
| USB0 | MIO, USB2 only |

Table 10: PS Interfaces

7.2 Constrains

7.2.1 Basic module constrains

_i_bitgen_common.xdc

```
set_property BITSTREAM.GENERAL.COMPRESS TRUE [current_design]
set_property BITSTREAM.CONFIG.UNUSEDPIN PULLNONE [current_design]
```

7.2.2 Design specific constrain

_i_io.xdc

```
set_property PACKAGE_PIN K9 [get_ports {SI5338_CLK0_D_clk_p[0]}]
set_property IOSTANDARD LVDS [get_ports {SI5338_CLK0_D_clk_p[0]}]
set_property DIFF_TERM TRUE [get_ports {SI5338_CLK0_D_clk_p[0]}]

set_property PACKAGE_PIN B13 [get_ports {x0[0]}]
set_property IOSTANDARD LVCMOS18 [get_ports {x0[0]}]
set_property PACKAGE_PIN B14 [get_ports {x1[0]}]
set_property IOSTANDARD LVCMOS18 [get_ports {x1[0]}]

set_property PACKAGE_PIN C13 [get_ports {PHY_LED[0]}]
set_property PACKAGE_PIN C14 [get_ports {PHY_LED[1]}]
set_property IOSTANDARD LVCMOS18 [get_ports {PHY_LED*}]
set_property PACKAGE_PIN A15 [get_ports {USRLED[0]}]
set_property IOSTANDARD LVCMOS18 [get_ports {USRLED*}]
set_property PACKAGE_PIN B14 [get_ports {x1[0]}]
set_property IOSTANDARD LVCMOS18 [get_ports {x1[0]}]
```

8 Software Design - Vitis

For Vitis project creation, follow instructions from:

[Vitis](#)²¹

8.1 Application

Template location: "<project folder>\sw_lib\sw_apps\"

8.1.1 zynqmp_fsbl

TE modified 2021.2 FSBL

General:

- Modified Files: xfsbl_main.c, xfsbl_hooks.h/.c, xfsbl_board.h/.c (search for 'TE Mod' on source code)
- Add Files: te_xfsbl_hooks.h/.c (for hooks and board)
- General Changes:
 - Display FSBL Banner and Device Name

Module Specific:

- Add Files: all TE Files start with te_
 - Si5338 Configuration
 - ETH+OTG Reset over MIO

8.1.2 zynqmp_fsbl_flash

TE modified 2021.2 FSBL

General:

- Modified Files: xfsbl_initialisation.c, xfsbl_hw.h, xfsbl_handoff.c, xfsbl_main.c
- General Changes:
 - Display FSBL Banner
 - Set FSBL Boot Mode to JTAG
 - Disable Memory initialisation

8.1.3 zynqmp_pmufw

Xilinx default PMU firmware.

8.1.4 hello_te0823

Hello TE0823 is a Xilinx Hello World example as endless loop instead of one console output.

²¹ <https://wiki.trenz-electronic.de/display/PD/Vitis>

8.1.5 u-boot

U-Boot.elf is generated with PetaLinux. Vitis is used to generate Boot.bin.

9 Software Design - PetaLinux

For PetaLinux installation and project creation, follow instructions from:

- [PetaLinux KICKstart](#)²²

9.1 Config

Start with **petalinux-config** or **petalinux-config --get-hw-description**

Changes:

- select SD default instead of eMMC:
 - CONFIG_SUBSYSTEM_PRIMARY_SD_PSU_SD_1_SELECT=y
- generate u-boot.dtb:
 - CONFIG_SUBSYSTEM_UBOOT_EXT_DTB=y
- add new flash partition for bootscr and sizing
 - CONFIG_SUBSYSTEM_FLASH_PSU_QSPI_0_BANKLESS_PART0_SIZE=0x2000000
 - CONFIG_SUBSYSTEM_FLASH_PSU_QSPI_0_BANKLESS_PART2_SIZE=0x2000000
 - CONFIG_SUBSYSTEM_FLASH_PSU_QSPI_0_BANKLESS_PART3_NAME="bootscr"
 - CONFIG_SUBSYSTEM_FLASH_PSU_QSPI_0_BANKLESS_PART3_SIZE=0x80000

9.2 U-Boot

Start with **petalinux-config -c u-boot**

Changes:

- MAC from eeprom together with uboot and device tree settings:
 - CONFIG_ENV_OVERWRITE=y
 - CONFIG_ZYNQ_GEM_I2C_MAC_OFFSET=0xFA
 - CONFIG_SYS_I2C_EEPROM_ADDR=0x50
- Boot Modes:
 - CONFIG_QSPI_BOOT=y
 - CONFIG_SD_BOOT=y
 - # CONFIG_ENV_IS_IN_NAND is not set
 - CONFIG_BOOT_SCRIPT_OFFSET=0x4040000

Change platform-top.h:

```
#include <configs/xilinx_zynqmp.h>
#no changes
```

9.3 Device Tree

```
project-spec\meta-user\recipes-bsp\device-tree\files\system-user.dtsi
```

```
/include/ "system-conf.dtsi"
```

²² <https://wiki.trenz-electronic.de/display/PD/PetaLinux+KICKstart>

```

/*----- QSPI ----- */
&qspi {
    #address-cells = <1>;
    #size-cells = <0>;
    status = "okay";
    flash0: flash@0 {
        //compatible = "flash name, "micron,m25p80";
        compatible = "jedec,spi-nor";
        reg = <0x0>;
        #address-cells = <1>;
        #size-cells = <1>;
    };
};

/*----- SD1 sd2.0 -----*/
&sdhci1 {
    disable-wp;
    no-1-8-v;
};

/*----- ETH PHY -----*/
&gem3 {
    phy-handle = <&phy0>;

    nvmem-cells = <&eth0_addr>;
    nvmem-cell-names = "mac-address";

    phy0: phy0@1 {
        device_type = "ethernet-phy";
        reg = <1>;
    };
};

/*----- USB 2.0 only -----*/
&dwc3_0 {
    status = "okay";
    dr_mode = "host";
    maximum-speed = "high-speed";
    /delete-property/phy-names;
    /delete-property/phys;
    /delete-property/snps,usb3_lpm_capable;
    snps,dis_u2_susphy_quirk;
    snps,dis_u3_susphy_quirk;
};

&usb0 {
    status = "okay";
    /delete-property/ clocks;
    /delete-property/ clock-names;
    clocks = <0x3 0x20>;
    clock-names = "bus_clk";
};

```

```

};

/*----- I2C -----*/
&i2c0 {
    eeprom: eeprom@50 {
        compatible = "microchip,24aa025", "atmel,24c02";
        reg = <0x50>;

        #address-cells = <1>;
        #size-cells = <1>;
        eth0_addr: eth-mac-addr@FA {
            reg = <0xFA 0x06>;
        };
    };
};

```

project-spec\meta-user\recipes-bsp\uboot-device-tree\files\system-user.dtsi

```

/include/ "system-conf.dtsi"

/*----- QSPI ----- */
&qspi {
    #address-cells = <1>;
    #size-cells = <0>;
    status = "okay";
    flash0: flash@0 {
        //compatible = "flash name, "micron,m25p80";
        compatible = "jedec,spi-nor";
        reg = <0x0>;
        #address-cells = <1>;
        #size-cells = <1>;
    };
};

/*----- SD1 sd2.0 -----*/
&sdhci1 {
    disable-wp;
    no-1-8-v;
};

/*----- ETH PHY -----*/
&gem3 {
    phy-handle = <&phy0>;

    nvmem-cells = <&eth0_addr>;
    nvmem-cell-names = "mac-address";
};

```

```
phy0: phy0@1 {
    device_type = "ethernet-phy";
    reg = <1>;
};

/*----- USB 2.0 only -----*/
&dwc3_0 {
    status = "okay";
    dr_mode = "host";
    maximum-speed = "high-speed";
    /delete-property/ phy-names;
    /delete-property/ phys;
    /delete-property/ snps,usb3_lpm_capable;
    snps,dis_u2_susphy_quirk;
    snps,dis_u3_susphy_quirk;
};

&usb0 {
    status = "okay";
    /delete-property/ clocks;
    /delete-property/ clock-names;
    clocks = <0x3 0x20>;
    clock-names = "bus_clk";
};

/*----- I2C -----*/
&i2c0 {
    eeprom: eeprom@50 {
        compatible = "microchip,24aa025", "atmel,24c02";
        reg = <0x50>;

        #address-cells = <1>;
        #size-cells = <1>;
        eth0_addr: eth-mac-addr@FA {
            reg = <0xFA 0x06>;
        };
    };
};
```

9.4 FSBL patch

Must be add manually, see template

9.5 Kernel

Start with **petalinux-config -c kernel**

Changes:

- Only needed to fix JTAG Debug issue:
 - CONFIG_CPU_IDLE is not set
 - CONFIG_CPU_FREQ is not set
 - CONFIG_EDAC_CORTEX_ARM64=y

9.6 Rootfs

Start with **petalinux-config -c rootfs**

Changes:

- For web server app:
 - CONFIG_busybox-httpd=y
- For additional test tools only:
 - CONFIG_i2c-tools=y
 - CONFIG_packagegroup-petalinux-utils=y (util-linux,cpufrequtils,bridge-utils,mtd-utils,usbutils,pciutils,canutils,i2c-tools,smartmontools,e2fsprogs)

9.7 Applications

See "<project folder>\os\petalinux\project-spec\meta-user\recipes-apps\"

9.7.1 startup

Script App to load init.sh from SD Card if available.

9.7.2 webfwu

Webserver application suitable for Zynq access. Need busybox-httpd

10 Additional Software

10.1 SI5338

File location "<project folder>\misc\PLL\Si5338\Si5338-*.slabtimeproj"

General documentation how you work with these project will be available on [Si5338](#)²³

²³ <https://wiki.trenz-electronic.de/display/PD/Si5338>

11 Appx. A: Change History and Legal Notices

11.1 Document Change History

To get content of older revision got to "Change History" of this page and select older document revision number.

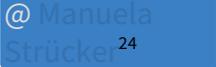
| Date | Document Revision | Authors | Description |
|--|-------------------|--|---|
|  2022-11-18 | v.13(see page 6) |  @ Manuela Strücker ²⁴ | <ul style="list-style-type: none"> • bugfix uncomment block design modifications in mod_bd.tcl • added jtag2axi for test purposes |
| 2022-10-25 | v.11 | Manuela Strücker | <ul style="list-style-type: none"> • Release Vivado 2021.2.1 • script update |
| 2022-10-27 | v.9 | John Hartfiel | <ul style="list-style-type: none"> • new design files and variants |
| 2021-08-24 | v.8 | John Hartfiel | <ul style="list-style-type: none"> • startup application added • webfwu application added |
| 2021-08-18 | v.7 | Mohsen Chamanbaz | <ul style="list-style-type: none"> • 2020.2 release |
| 2020-03-17 | v.4 | John Hartfiel | <ul style="list-style-type: none"> • 2019.2 release |
| | All |  @ Mohsen Chamanbaz ²⁵ , John Hartfiel ²⁶ , Manuela Strücker ²⁷ | |

Table 11: Document change history.

²⁴ <https://wiki.trenz-electronic.de/display/~m.stuecker>

²⁵ <https://wiki.trenz-electronic.de/display/~M.Chamanbaz>

²⁶ <https://wiki.trenz-electronic.de/display/~j.hartfiel>

²⁷ <https://wiki.trenz-electronic.de/display/~m.stuecker>

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 2019-06-07

²⁸ <http://guidance.echa.europa.eu/>

²⁹ <https://echa.europa.eu/candidate-list-table>

³⁰ <http://www.echa.europa.eu/>